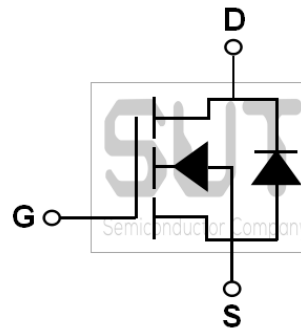
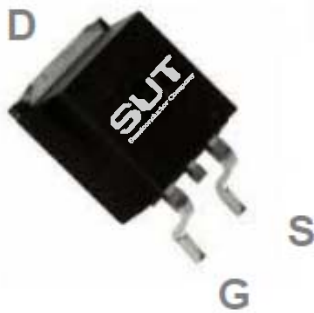


N-Channel 100-V_(D-S) SGT MOSFET

PRODUCT SUMMARY		
B _{VDSS} (V)	R _{DS(on)} (mΩ)(MAX)	I _D (A)
100	6.0@V _{GS} =10V	120

TO263 Pin Configuration



ABSOLUTE MAXIMUM RATINGS(T_C=25°C UNLESS OTHERWISE NOTED)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V _{DS}	100	V
Gate-Source Voltage	V _{GS}	+20/-12	V
Drain Current-Continuous (T _C =25°C)	I _D	120	A
Drain Current-Continuous (T _C =100°C)		73	A
Drain Current-Pulsed ¹	I _{DM}	400	A
Single Pulse Avalanche Energy ²	EAS	151	mJ
Single Pulse Avalanche Current ²	IAS	55	A
Power Dissipation (T _C =25°C)	P _D	184	W
Power Dissipation-Derate above 25°C		1.47	W/°C
Storage Temperature Range	T _{STG}	-50 to 150	°C
Operating Junction Temperature Range	T _J	-50 to 150	°C

THERMAL CHARACTERISTICS

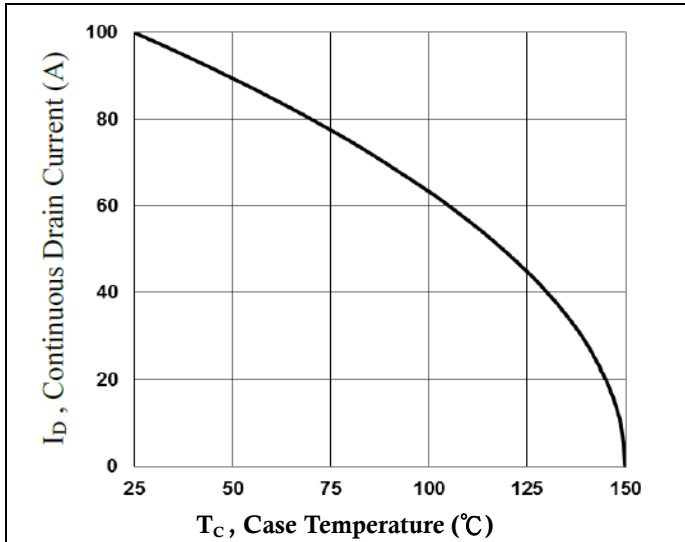
Parameter	Symbol	Typ.	Max.	Unit
Thermal Resistance Junction to ambient	R _{θJA}	---	62	°C/W
Thermal Resistance Junction to Case	R _{θJC}	---	0.68	°C/W

ELECTRICAL CHARACTERISTICS (T _J =25°C UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	100	---	---	V
Drain-Source Leakage Current	I _{DSS}	V _{GS} =0V, V _{DS} =100V, T _J =25°C	---	---	1	uA
		V _{GS} =0V, V _{DS} =80V, T _J =85°C	---	---	10	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =20V, V _{DS} =0V	---	---	100	nA
On Characteristics						
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =20A	---	5.0	6.0	mΩ
		V _{GS} =6V, I _D =10A	---	6.5	8.8	mΩ
Gate Threshold Voltage	V _{GS(th)}	V _{GS} =V _{DS} , I _D =250uA	2.0	---	4.0	V
Forward Transconductance	g _{fs}	V _{DS} =10V, I _D =5A	---	8.0	---	S
Dynamic and Switching Characteristics						
Total Gate Charge ^{3, 4}	Q _g	V _{GS} =10V, V _{DS} =80V, I _D =10A	---	57.9	110	nC
Gate-Source Charge ^{3, 4}	Q _{gs}		---	10.8	20	
Gate-Drain Charge ^{3, 4}	Q _{gd}		---	18.2	38	
Turn-On Delay Time ^{3, 4}	T _{d(on)}	V _{GS} =10V, V _{DD} =50V, R _G =6Ω, I _D =1A	---	24	48	ns
Rise Time ^{3, 4}	T _r		---	19.8	39	
Turn-Off Delay Time ^{3, 4}	T _{d(off)}		---	46	92	
Fall Time ^{3, 4}	T _f		---	26	52	
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =50V, F=1MHz	---	3590	7180	pF
Output Capacitance	C _{oss}		---	590	1180	
Reverse Transfer Capacitance	C _{rss}		---	30	60	
Gate resistance	R _g	V _{GS} =0V, V _{DS} =0V, F=1MHz	---	1.5	3.0	Ω
Drain-Source Diode Characteristics and Maximum Ratings						
Continuous Source Current	I _S	V _G =V _D =0V, Force Current	---	---	100	A
Pulsed Source Current	I _{SM}		---	---	200	A
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =1A, T _J =25°C	---	---	1.0	V
Reverse Recovery Time	t _{rr}	V _{GS} =0V, I _S =10A, di/dt=100A/μs, T _J =25°C	---	60	---	ns
Reverse Recovery Charge	Q _{rr}		---	117	---	nC

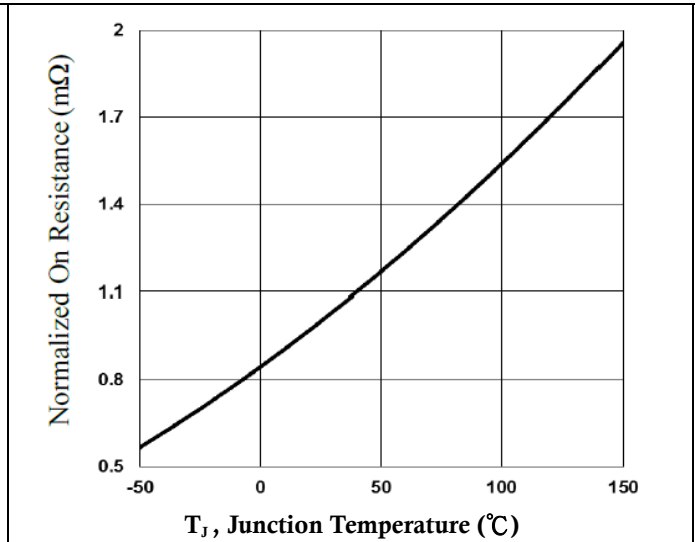
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. V_{GS}=10V, V_{DD}=25V, L=0.1mH, I_{AS}=55A, R_G=25Ω, Starting T_J=25°C.
3. The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%.
4. Essentially independent of operating temperature.

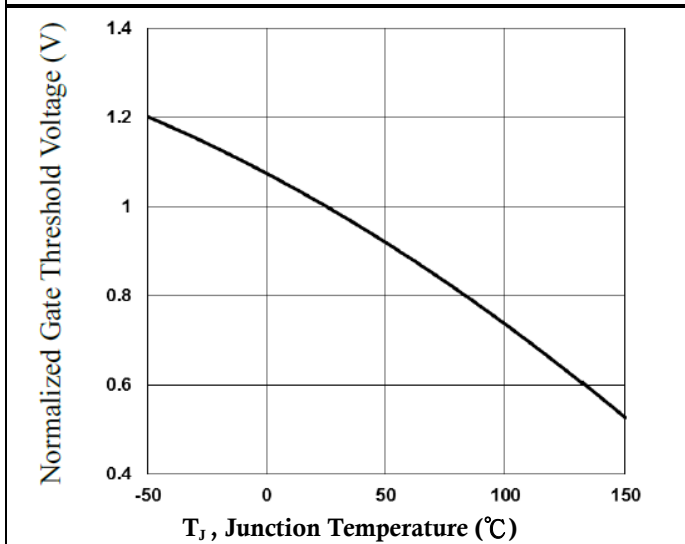
100V N-Channel MOSFETs



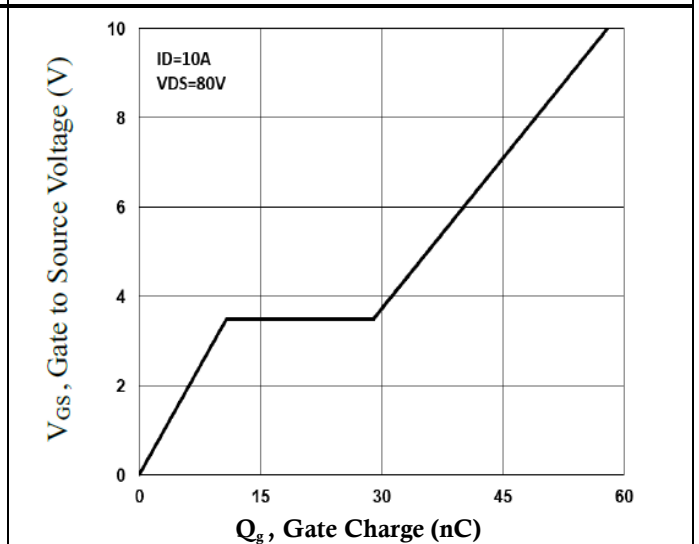
Continuous Drain Current vs. T_C



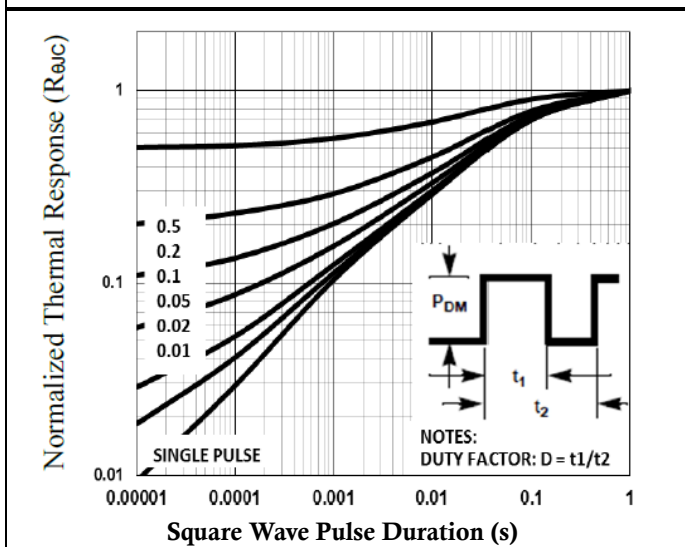
Normalized $R_{DS(ON)}$ vs. T_J



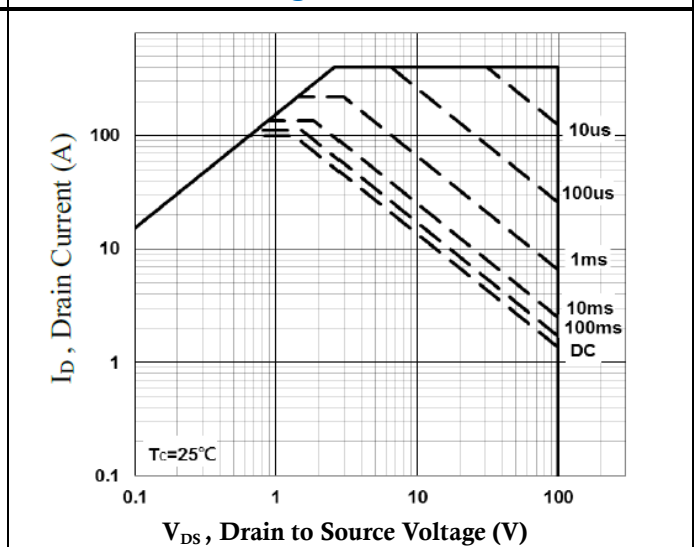
Normalized V_{th} vs. T_J



Gate Charge Characteristics



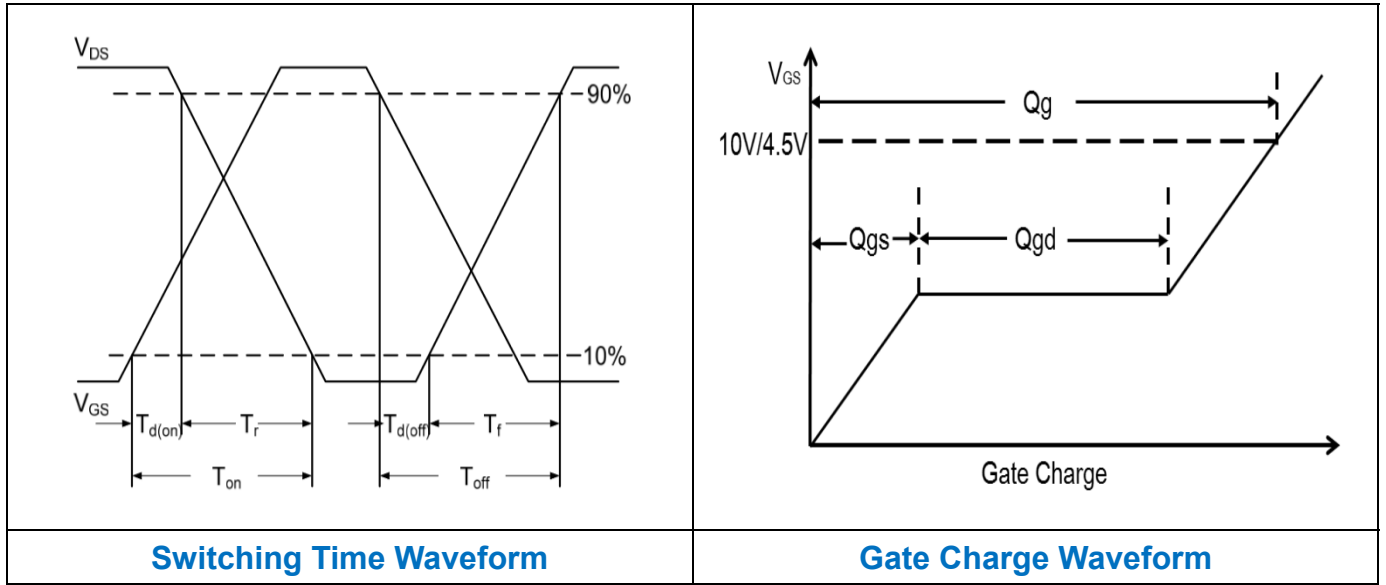
Normalized Transient Impedance



Maximum Safe Operation Area

SUT9074Z

100V N-Channel MOSFETs



TO263 PACKAGE INFORMATION

